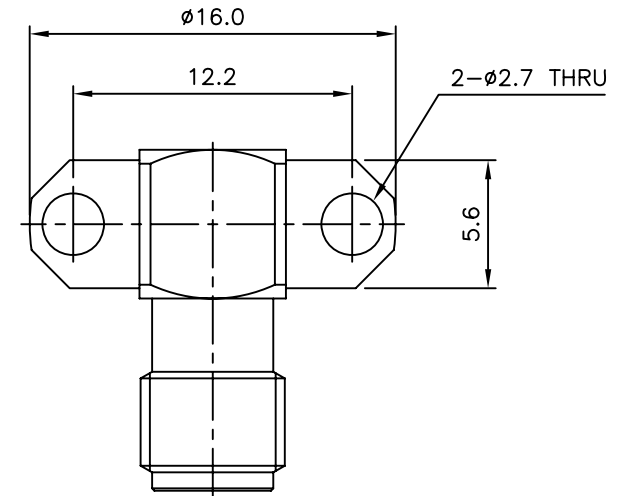
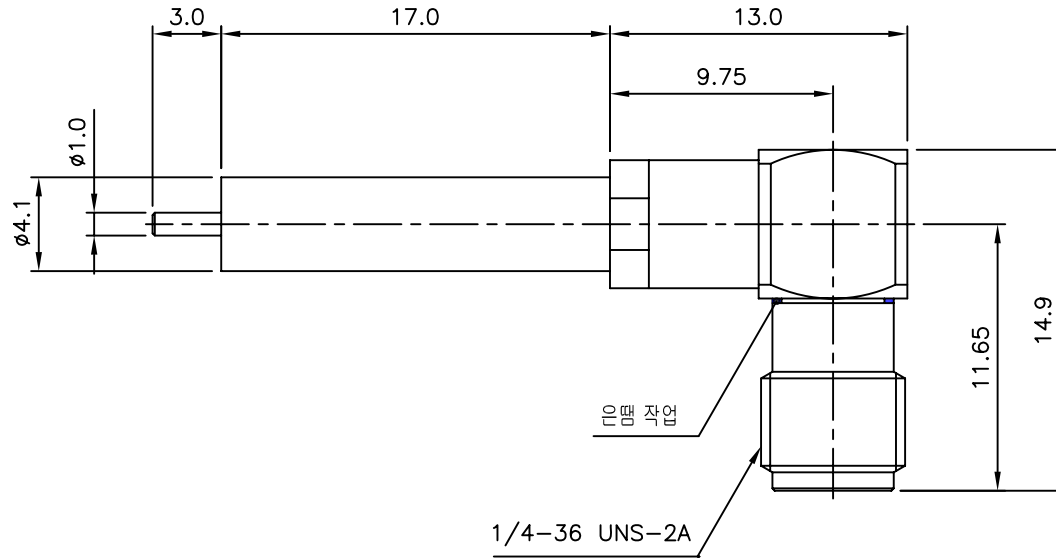


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2021.09.28.



■ 가공공차 : ISO-2768-F급 관리

6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00042-5/3
5	INSULATOR	1	TEFLON		DIN03253-N/1
4	INSULATOR	1	TEFLON		DIN00112-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03671-5/4
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00151-5/1
1	1-2 BODY(B)	1	MBsBD C3604BD-F	Nickel Plate	DBD00206-1/1
	1-1 BODY(A)	1	MBsBD C3604BD-F	Nickel Plate	DBD00223-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2021. 09. 28.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JL-2H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	3/1	A4 DWG NO. CN03585-7/5 REVISION I R SHEET 1 of 1
		UNIT	mm	